Electronic Patent Application Fee Transmittal							
Application Number:	10	10691085					
Filing Date:	22-Oct-2003						
Title of Invention:	HYBRID CIRCUIT SUBSTRATE WITH OPTICAL AND ELECTRICAL INTERCONNECTS, HYBRID CIRCUIT MODULE WITH OPTICAL AND ELECTRICAL INTERCONNECTS AND MANUFACTURING METHODS THEREOF						
First Named Inventor/Applicant Name:	Tsuyoshi Ogawa						
Filer:	David Richard Metzger/Paula Theismann						
Attorney Docket Number:	09792909-5704						
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Basic Filing:							
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